MOSFET – Power, Single, N-Channel, μCool, UDFN6, 1.6x1.6x0.55 mm 30 V, 11.7 A

Features

- UDFN Package with Exposed Drain Pads for Excellent Thermal Conduction
- Low Profile UDFN 1.6 x 1.6 x 0.55 mm for Board Space Saving
- Ultra Low R_{DS(on)}
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Power Load Switch
- Wireless Charging
- DC-DC Converters

MAXIMUM RATINGS ($T_J = 25^{\circ}C$ unless otherwise stated)

Pa	rameter		Symbol	Value	Unit
Drain-to-Source Vo	ltage		V _{DSS}	30	V
Gate-to-Source Vol	tage		V _{GS}	±12	V
Continuous Drain Steady		$T_A = 25^{\circ}C$	۱ _D	9.4	А
Current (Note 1)	State	T _A = 85°C		6.8	
	t ≤ 5 s	T _A = 25°C	1	11.7	
Power Dissipa- tion (Note 1)	Steady State	T _A = 25°C	PD	1.53	W
	t ≤ 5 s	$T_A = 25^{\circ}C$		2.37	
Continuous Drain	Steady	$T_A = 25^{\circ}C$	I _D	6.1	А
Current (Note 2)	State	T _A = 85°C	1	4.4	
Power Dissipation (Note 2)	T _A = 25°C	PD	0.65	W
Pulsed Drain Curre	nt	t _p = 10 μs	I _{DM}	28	А
MOSFET Operating Junction and Storage Temperature			T _J , T _{STG}	-55 to 150	°C
Source Current (Body Diode) (Note 1)			۱ _S	2.0	А
Lead Temperature (1/8" from case for		g Purposes	ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface Mounted on FR4 Board using 1 in sq pad size (Cu area = 1.127 in sq [2 oz] including traces).

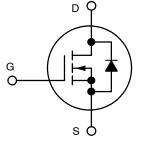
2. Surface-mounted on FR4 board using the minimum recommended pad size, 2 oz. Cu.



ON Semiconductor®

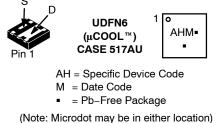
www.onsemi.com

MOSFET						
V _{(BR)DSS}	I _D MAX					
	11.4 m Ω @ 10 V					
	13.3 mΩ @ 4.5 V					
30 V	14.2 mΩ @ 3.7 V	11.7 A				
50 V	15.2 mΩ @ 3.3 V	11.7 A				
	20 mΩ @ 2.5 V					
	40 mΩ @ 1.8 V					

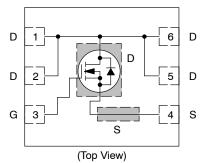


N-CHANNEL MOSFET

MARKING DIAGRAM



PIN CONNECTIONS



ORDERING INFORMATION

See detailed ordering and shipping information on page 3 of this data sheet.

THERMAL RESISTANCE RATINGS

Parameter		Max	Unit
Junction-to-Ambient – Steady State (Note 3)	R_{\thetaJA}	81.7	
Junction-to-Ambient – t \leq 5 s (Note 3)	R_{\thetaJA}	52.8	°C/W
Junction-to-Ambient – Steady State min Pad (Note 4)	R_{\thetaJA}	193.6	

3. Surface-mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [2 oz] including traces).

4. Surface-mounted on FR4 board using the minimum recommended pad size, 2 oz. Cu.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Co	ondition	Min	Тур	Max	Units
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V,	I _D = 250 μA	30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	$I_D = 250 \ \mu\text{A}$, ref to 25°C			11		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$ $T_J = 25^{\circ}C$				1	μΑ
		$V_{DS} = 24 V$	T _J = 125°C			10	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$				±100	nA

ON CHARACTERISTICS (Note 5)

Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$	0.6		1.1	V
Negative Threshold Temp. Coefficient	V _{GS(TH)} /T _J			3		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V_{GS} = 10 V, I _D = 8.0 A		9.3	11.4	mΩ
		V_{GS} = 4.5 V, I _D = 5.0 A		10.7	13.3	
		V_{GS} = 3.7 V, I _D = 3.0 A		11.4	14.2	
		V_{GS} = 3.3 V, I _D = 3.0 A		12.0	15.2	
		V_{GS} = 2.5 V, I _D = 2.5 A		14.3	20	
		V_{GS} = 1.8 V, I _D = 2.5 A		26	40	
Forward Transconductance	9fs	V_{DS} = 1.5 V, I _D = 5.0 A		31		S

CHARGES, CAPACITANCES & GATE RESISTANCE

Input Capacitance	C _{ISS}		690	pF
Output Capacitance	C _{OSS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 15 V	305	
Reverse Transfer Capacitance	C _{RSS}		26	
Total Gate Charge	Q _{G(TOT)}		7.5	nC
Threshold Gate Charge	Q _{G(TH)}	V_{GS} = 4.5 V, V_{DS} = 15 V; I _D = 5.0 A	0.6	
Gate-to-Source Charge	Q _{GS}	$I_D = 5.0 \text{ Å}$	1.3	
Gate-to-Drain Charge	Q _{GD}		1.4	

SWITCHING CHARACTERISTICS, V_{GS} = 4.5 V (Note 6)

Turn-On Delay Time	t _{d(ON)}		6.0	ns
Rise Time	t _r	V _{GS} = 4.5 V, V _{DD} = 15 V,	14.5	
Turn-Off Delay Time	t _{d(OFF)}	I_D = 5.0 A, R_G = 1 Ω	17.5	
Fall Time	t _f		2.5	

DRAIN-SOURCE DIODE CHARACTERISTICS

Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$	0.7	1.0	V
		I _S = 2.0 A	T _J = 125°C	0.5		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 5. Pulse Test: pulse width \leq 300 μ s, duty cycle \leq 2%.

6. Switching characteristics are independent of operating junction temperatures.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units	
DRAIN-SOURCE DIODE CHARACTERISTICS							
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dls/dt = 100 A/µs, I _S = 2.0 A		21		ns	
Charge Time	t _a			11			
Discharge Time	t _b			10			
Reverse Recovery Charge	Q _{RR}			10.5		nC	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 5. Pulse Test: pulse width \leq 300 µs, duty cycle \leq 2%.

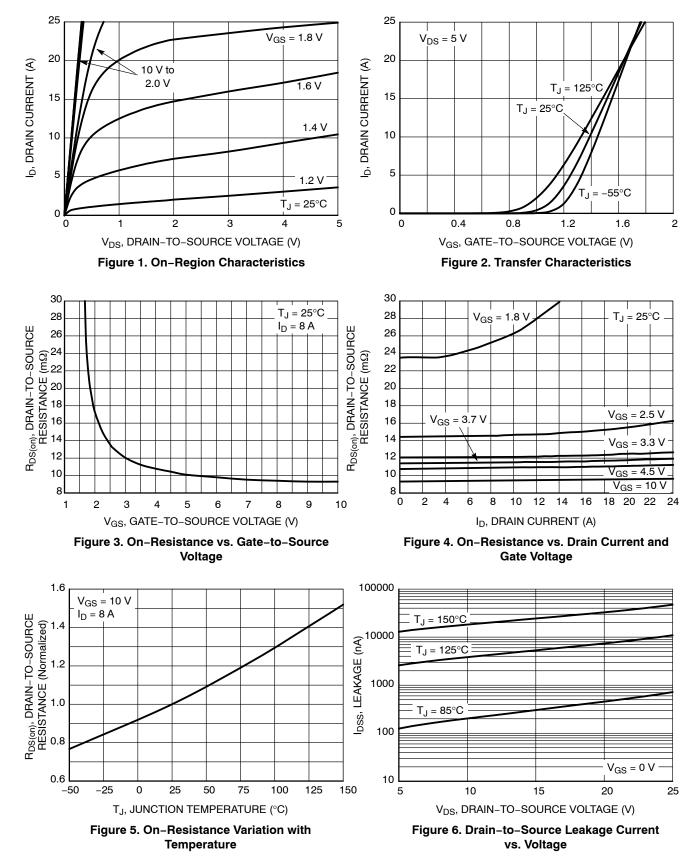
6. Switching characteristics are independent of operating junction temperatures.

DEVICE ORDERING INFORMATION

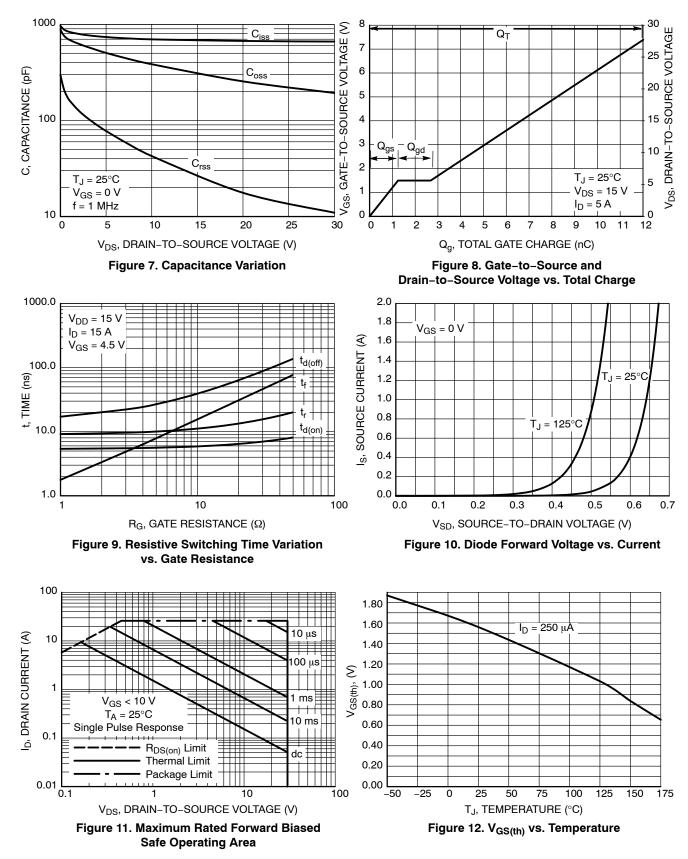
Device	Package	Shipping [†]
NTLUS4C16NTAG	UDFN6 (Pb-Free)	3000 / Tape & Reel
NTLUS4C16NTBG	UDFN6 (Pb-Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

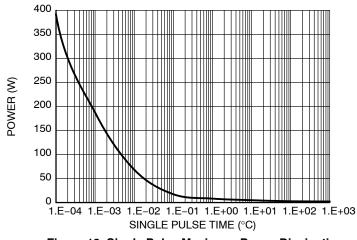
TYPICAL CHARACTERISTICS



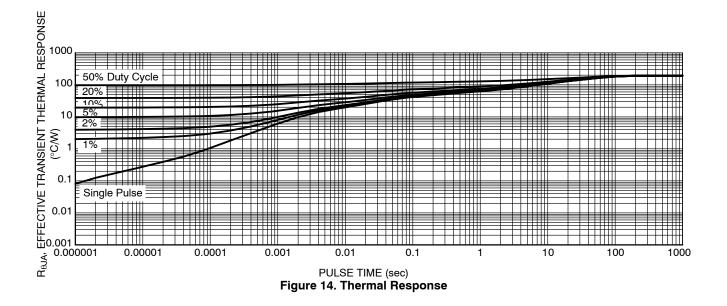
TYPICAL CHARACTERISTICS



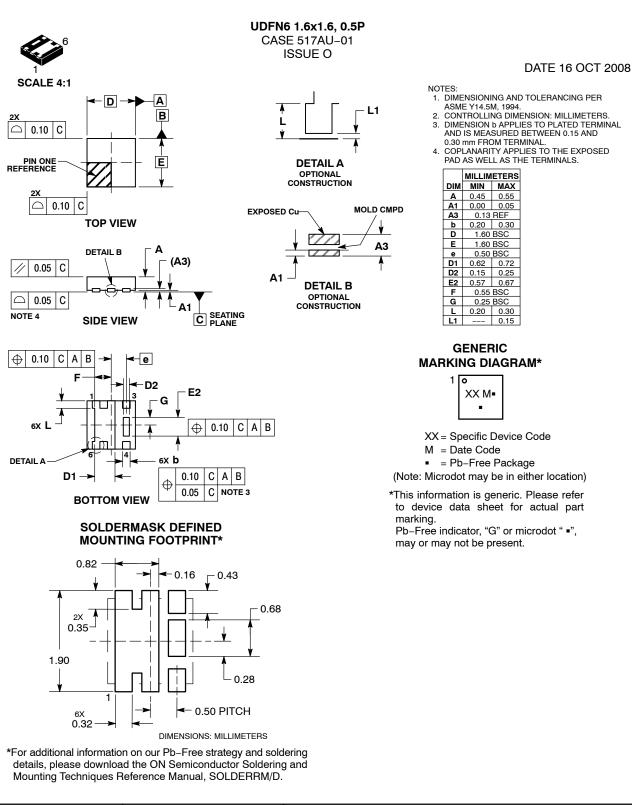
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